

ABSTRACT OF DISLCOSURE

5 A CPU chip-cooling device is provided. The CPU chip is
disposed on a chassis, and the cooling device comprises a heat
sink, a bracket and a fan. The heat sink is disposed on the
CPU chip. The bracket, having a pivot portion and a retention
portion, is pivotally disposed on the chassis by the pivot
portion. The fan is disposed on the bracket. The fan is
10 adjacent to the heat sink when the bracket engages with the
chassis by the retention portion. The fan is away from the
heat sink when the retention portion of the bracket does not
engage with the chassis.